



## Final Product/Process Change Notification

Document #:FPCN25591X

Issue Date:15 Apr 2024

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|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|
| <b>Title of Change:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | Additional wafer fabrication sites for the Eco SWITCH family of products using ONC25HV technology for the controller die at onsemi Aizu facility and using T6 technology for the FET die at onsemi East Fishkill facility.                                                                                                                                       |                                                                            |
| <b>Proposed First Ship date:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | 22 Jul 2024 or earlier if approved by customer                                                                                                                                                                                                                                                                                                                   |                                                                            |
| <b>Contact Information:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | Contact your local onsemi Sales Office or <a href="mailto:Eric.Andrade@onsemi.com">Eric.Andrade@onsemi.com</a>                                                                                                                                                                                                                                                   |                                                                            |
| <b>PCN Samples Contact:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | Contact your local onsemi Sales Office.<br>Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change.<br>Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.                                                |                                                                            |
| <b>Additional Reliability Data:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | Contact your local onsemi Sales Office or <a href="mailto:Jim.Workman@onsemi.com">Jim.Workman@onsemi.com</a>                                                                                                                                                                                                                                                     |                                                                            |
| <b>Type of Notification:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change.<br>onsemi will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <a href="mailto:PCN.Support@onsemi.com">PCN.Support@onsemi.com</a> |                                                                            |
| <b>Marking of Parts/ Traceability of Change:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Changed material may be identified by date code.                                                                                                                                                                                                                                                                                                                 |                                                                            |
| <b>Change Category:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | Wafer Fab Change                                                                                                                                                                                                                                                                                                                                                 |                                                                            |
| <b>Change Sub-Category(s):</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Datasheet/Product Doc change, Manufacturing Site Addition                                                                                                                                                                                                                                                                                                        |                                                                            |
| <b>Sites Affected:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                                                                                                                                                                                                                  |                                                                            |
| <b>onsemi Sites</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | <b>External Foundry/Subcon Sites</b>                                                                                                                                                                                                                                                                                                                             |                                                                            |
| onsemi Aizu, Japan                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | None                                                                                                                                                                                                                                                                                                                                                             |                                                                            |
| onsemi East Fishkill, New York, United States                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                                                                                                                                                                                                                                                                                                  |                                                                            |
| <b>Description and Purpose:</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                  |                                                                            |
| <p>This FPCN is to announce the qualification completion of additional wafer fabrication sites for the Eco SWITCH family of products. Eco SWITCH products contain 2 distinct parts namely, a controller and a FET. The controller which utilizes onsemi ONC25HV technology is being qualified at onsemi Aizu located in Aizu, Japan as an additional site. The FET which utilizes onsemi Trench 6 technology is being qualified at onsemi East Fishkill facility located in East Fishkill, US as an additional site for the FET die.</p> <p>The Probe and Backgrind process for the East Fishkill T6 FET will be done at East Fishkill, US.</p> |                                                                                                                                                                                                                                                                                                                                                                  |                                                                            |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | <b>From</b>                                                                                                                                                                                                                                                                                                                                                      | <b>To</b>                                                                  |
| <b>Fab Site – Controller die</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | onsemi Gresham, US                                                                                                                                                                                                                                                                                                                                               | onsemi Gresham, US or<br>onsemi Aizu, Japan                                |
| <b>Fab Site – FET die</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | onsemi Aizu, Japan                                                                                                                                                                                                                                                                                                                                               | onsemi Aizu, Japan or<br>onsemi East Fishkill, US                          |
| <b>Wafer Size – FET die</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | 200mm at onsemi Aizu, Japan                                                                                                                                                                                                                                                                                                                                      | 200mm at onsemi Aizu, Japan or<br>300mm at onsemi East Fishkill, US        |
| <b>Probe Site – FET die</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | 200mm at onsemi Seremban, Malaysia                                                                                                                                                                                                                                                                                                                               | 200mm at onsemi Seremban, Malaysia or<br>300mm at onsemi East Fishkill, US |
| <b>Backgrind Site – FET die</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | 200mm at onsemi ISMF, Malaysia                                                                                                                                                                                                                                                                                                                                   | 200mm at onsemi ISMF, Malaysia or<br>300mm at onsemi East Fishkill, US     |
| There is no product marking change as a result of this change.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                                                                                                                                                                                                                                                  |                                                                            |

## Reliability Data Summary:

QV DEVICE NAME: NCP45790IMN24RTWG, NCP45770IMN24TWG (FET only)

RMS: O91749, O91750 (FET only)

PACKAGE: DFN14 4x4

| Test                                         | Specification          | Condition                                           | Interval   | Results |
|----------------------------------------------|------------------------|-----------------------------------------------------|------------|---------|
| Intermittent Operating Life (FET only)       | MIL-STD-750 mtd 1037   | Ta=+25°C, delta Tj=100°C max, 3.5min = Ton = Toff   | 15,000 cyc | 0/135   |
| High Temperature Gate Bias (FET only)        | JESD22-A108            | Tj=150°C (Max rate for FET), bias = 100% of rated V | 1008 hrs   | 0/231   |
| High Temperature Reverse Bias (FET only)     | JESD22-A108            | Tj=150°C (Max rate for FET), bias = 100% of rated V | 1008 hrs   | 0/231   |
| High Temperature Operating Life              | JESD22-A108            | Ta=125°C, 100 % max rated Vcc                       | 1008 hrs   | 0/231   |
| High Temperature Storage Life                | JESD22-A103            | Ta= 150°C                                           | 1008 hrs   | 0/231   |
| Moisture Preconditioning                     | J-STD-020<br>JESD-A113 | MSL3 @ 260°C                                        | -          | 0/1232  |
| Temperature Cycling                          | JESD22-A104            | -65°C to +150°C                                     | 500 cyc    | 0/231   |
| Highly Accelerated Stress Test               | JESD22-A110            | 110°C, 85% RH, 17.7psig, bias                       | 264 hrs    | 0/231   |
| Unbiased Highly Accelerated Stress Test      | JESD22-A118            | 130°C, 85% RH, 18.8psig, unbiased                   | 96 hrs     | 0/231   |
| Electrostatic Discharge Human Body Model     | JS-001                 | Test up to 3kV<br>3 parts per V-step                | 500 V      | 0/3     |
|                                              |                        |                                                     | 1000 V     | 0/3     |
|                                              |                        |                                                     | 1500 V     | 0/3     |
|                                              |                        |                                                     | 2000 V     | 0/3     |
|                                              |                        |                                                     | 2500 V     | 0/3     |
|                                              |                        |                                                     | 3000 V     | 0/3     |
| Electrostatic Discharge Charged Device Model | JS-002                 | Test up to 750V<br>3 parts per V-step               | 125 V      | 0/3     |
|                                              |                        |                                                     | 250 V      | 0/3     |
|                                              |                        |                                                     | 500 V      | 0/3     |
|                                              |                        |                                                     | 750 V      | 0/3     |
| Latch Up                                     | JESD78 Class II        | Tj max, +/- 100mA, 1.5x VDD                         | -          | 0/6     |
| Scanning Acoustic Analysis                   | J-STD-020              | Compare pre/post PC devices                         | -          | 0/88    |
| Bond Pull Strength                           | MIL-STD883 mtd 2011    | Min Cpk 1.33                                        | -          | 0/30    |

## Electrical Characteristics Summary:

Affected parts will have datasheet updates to the following:

|                                                             | From                             | To          |
|-------------------------------------------------------------|----------------------------------|-------------|
| Over-Current Protection Trip ( $R_{OCp=open}$ ), $I_{TRIP}$ | MAX (refer to datasheet per OPN) | MAX + 200mA |
| Power Good Turn-On Time (All conditions), $T_{PG,ON}$       | MAX (refer to datasheet per OPN) | MAX + 1.5ms |



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### List of Affected Parts:

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

| Part Number       | Qualification Vehicle |
|-------------------|-----------------------|
| NCP45750IMN24TWG  | NCP45790IMN24RTWG     |
| NCP45760IMN24RTWG | NCP45790IMN24RTWG     |
| NCP45770IMN24TWG  | NCP45790IMN24RTWG     |
| NCP45780IMN24RTWG | NCP45790IMN24RTWG     |
| NCP45790IMN24RTWG | NCP45790IMN24RTWG     |

Appendix A: Changed Products

PCN#: FPCN25591X  
Issue Date: Apr 14, 2024

DIKG: DIGI-KEY

| Product           | Customer Part Number | Qualification Vehicle | New Part Number | Replacement Supplier |
|-------------------|----------------------|-----------------------|-----------------|----------------------|
| NCP45750IMN24TWG  |                      | NCP45790IMN24RTWG     | #NONE           |                      |
| NCP45770IMN24TWG  |                      | NCP45790IMN24RTWG     | #NONE           |                      |
| NCP45780IMN24RTWG |                      | NCP45790IMN24RTWG     | #NONE           |                      |
| NCP45790IMN24RTWG |                      | NCP45790IMN24RTWG     | #NONE           |                      |
| NCP45760IMN24RTWG |                      | NCP45790IMN24RTWG     | #NONE           |                      |